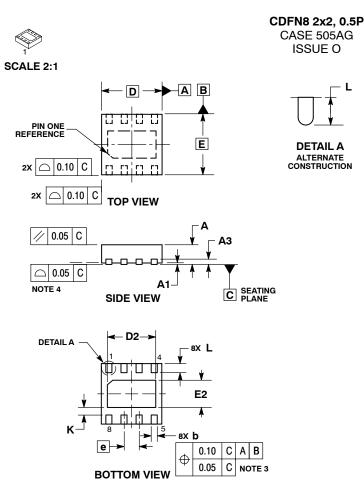
semi



DATE 20 AUG 2012

L

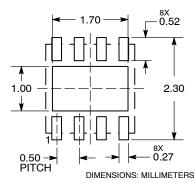
- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.10 AND 0.20MM FROM THE TERMINAL TIP. 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.60	0.70	
A1	0.00	0.05	
A3	0.20 REF		
b	0.15	0.25	
D	2.00 BSC		
D1	1.80 BSC		
D2	1.45	1.70	
Е	2.00 BSC		
E2	0.75	1.00	
е	0.50 BSC		
К	0.15		
L	0.20	0.40	

GENERIC **MARKING DIAGRAM***

*No marking due to clear package

RECOMMENDED **MOUNTING FOOTPRINT***



*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	CDFN8, 2X2, 0.5P		PAGE 1 OF 1

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